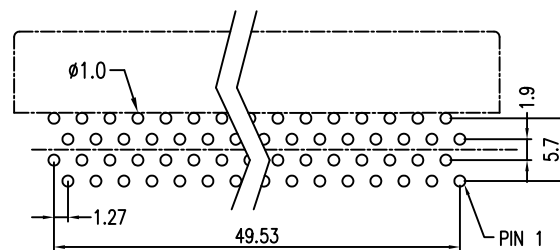
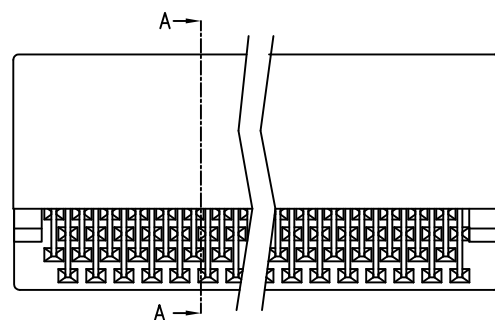


SECTION A-A



RECOMMENDED PCB LAYOUT (TOP VIEW)

MATERIAL

INSULATOR: GLASS-REINFORCED THERMOPLASTIC.

CONTACT: COPPER ALLOY.

PLATING: MATING AREA - GOLD FLASH GOLD OVER NICKEL.

SOLDER AREA - TIN OVER NICKEL.

ELECTRICAL

VOLTAGE RATING: 250 VAC RMS.

CURRENT RATING: 1 AMP.

DIELECTRIC WITHSTANDING VOLTAGE: 500 VAC RMS 60Hz
FOR 1 MINUTE.

INSULATION RESISTANCE: 1000 MEGOHMS MIN AT 500 VDC.

CONTACT RESISTANCE: 30 MILLIOHMS MAX.

MECHANICAL

RETENTION FORCE: 460 GRAMS MIN PER CONTACT.

INSERTION FORCE: 230 GRAMS MAX PER CONTACT PAIR.

WITHDRAWAL FORCE: 15 GRAMS MIN PER CONTACT PAIR.

ENVIRONMENTAL

TEMPERATURE RANGE: -55°C TO +85°C.

Recommended P.C.B Layout